2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

General Description

The MAX2837 direct-conversion zero-IF RF transceiver is designed specifically for 2.3GHz to 2.7GHz wireless broadband systems. The MAX2837 completely integrates all circuitry required to implement the RF transceiver function, providing RF-to-baseband receive path; and baseband-to-RF transmit path, VCO, frequency synthesizer, crystal oscillator, and baseband/control interface. The device includes a fast-settling sigma-delta RF synthesizer with smaller than 20Hz frequency steps and a crystal oscillator, which allows the use of a low-cost crystal in place of a TCXO. The transceiver IC also integrates circuits for on-chip DC offset cancellation, I/Q error, and carrier-leakage detection circuits. Only an RF bandpass filter (BPF), crystal, RF switch, PA, and a small number of passive components are needed to form a complete wireless broadband RF radio solution.

The MAX2837 completely eliminates the need for an external SAW filter by implementing on-chip monolithic filters for both the receiver and transmitter. The baseband filters along with the Rx and Tx signal paths are optimized to meet stringent noise figure and linearity specifications. The device supports up to 2048 FFT OFDM and implements programmable channel filters for 1.75MHz to 28MHz RF channel bandwidths. The transceiver requires only 2µs Tx-Rx switching time, which includes frequency transient settling. The IC is available in a small, 48-pin thin QFN package measuring only 6mm x 6mm x 0.8mm.

Applications

- 802.16-2004 Fixed WiMAX®
- Korea Wibro and 802.16e Mobile WiMAX
- Dual Mode™ WiMAX/802.11b/g Wi-Fi
- Proprietary Wireless Broadband Systems
- 4G/LTE Systems

Features

- 2.3GHz to 2.7GHz Wideband Operation
- Complete RF Transceiver, PA Driver, and Crystal Oscillator
 - OdBm Linear OFDM Transmit Power
 - -70dBr Tx Spectral Emission Mask
 - 2.3dB Rx Noise Figure
 - Tx/Rx I/Q Error and LO Leakage Detection
 - Monolithic Low-Noise VCO with -39dBc Integrated Phase Noise
 - Programmable Tx I/Q Lowpass Anti-Aliasing Filter
 - Sigma-Delta Fractional-N PLL with 20Hz Step Size
 - 45dB Tx Gain-Control Range
 - 94dB Receive Gain-Control Range
 - 60dB Analog RSSI Instantaneous Dynamic Range
 - 4-Wire SPI Digital Interface
 - I/Q Analog Baseband Interface
 - · Digitally Tuned Crystal Oscillator
 - On-Chip Digital Temperature Sensor Read-Out
- +2.7V to +3.6V Transceiver Supply
- Low-Power Shutdown Current
- Small 48-Pin Thin QFN Package (6mm x 6mm x 0.8mm)

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX2837ETM+TD	-40°C to +85°C	48 TQFN-EP*

*EP = Exposed pad.

+Denotes a lead(Pb)-free/RoHS-compliant package.

Pin Configuration appears at end of data sheet.

Dual Mode is a trademark of Maxim Integrated Products, Inc. WiMAX is a registered certification mark and registered service mark of the WiMAX Forum.



2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Absolute Maximum Ratings

V _{CCLNA} , V _{CCTXMX} , V _{CCTXPAD} , V _{CCDIG} , V _{CCCP} , V _{CCXTAL} ,
V _{CCVCO} , V _{CCRXVGA} , V _{CCRXFL} and V _{CCRXMX} to
GND0.3V to +3.9V
B1–B7, TXRF_, CS, SCLK, DIN, DOUT, TXBBI_, TXBBQ_,
RXHP, RXBBI_, RXBBQ_, RSSI, ENABLE, BYPASS,
CPOUT_, CLOCKOUT, XTAL1, XTAL2, RXRF_,RXENABLE,
TXENABLE to GND0.3V to (Operating V _{CC} + 0.3V)
RXBBI_, RXBBQ_, RSSI, BYPASS, CPOUT_, DOUT, CLOCKOUT,
PABIAS Short-Circuit Duration 10s
RF Input Power+10dBm

Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
48-Pin Thin QFN (derates 37mW/°C above +70°C)2.96W	
Operating Temperature Range40°C to +85°C	
Junction Temperature+150°C	
Storage Temperature Range65°C to +160°C	
Lead Temperature (soldering, 10s)+260°C	

CAUTION! ESD SENSITIVE DEVICE

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC Electrical Characteristics

(MAX2837 evaluation kit: V_{CC} = 2.7V to 3.6V, Rx set to the maximum gain; \overline{CS} = high, RXHP = SCLK = DIN = low, RSSI and clock output buffer are off, no signal at RF inputs, all RF inputs and outputs terminated into 50 Ω , receiver baseband outputs are open; 90mV_{RMS} differential I and Q signals applied to I, Q baseband inputs of transmitter in transmit mode, f_{REF} = 40MHz, registers set to recommended settings and corresponding test mode, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = 2.8V, f_{LO} = 2.5GHz, and T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	V _{CC} _	2.7		3.6	V
	Shutdown mode, T _A = +25°C		10		μA
	Standby mode		35	45	
Supply Current	Rx mode		91	110	
Supply Current	Tx mode, $T_A = +25^{\circ}C$		145	170	mA
	Rx calibration mode		135	160	
	Tx calibration mode		110	135	
	D9:D8 = 00 in A4:A0 = 00100	0.85	1.0	1.20	
Rx I/Q Output Common-Mode	D9:D8 = 01 in A4:A0 = 00100		1.1		V
Voltage	D9:D8 = 10 in A4:A0 = 00100	1.2] V
	D9:D8 = 11 in A4:A0 = 00100		1.35		
Tx Baseband Input Common- Mode Voltage Operating Range	DC-coupled	0.5		1.2	V
Tx Baseband Input Bias Current	Source current		10	20	μA
LOGIC INPUTS: ENABLE, TXEN	ABLE, RXENABLE, SCLK, DIN, CS, B7:B1, RXHP	·			•
Digital Input-Voltage High, V _{IH}		V _{CC} - 0	.4		V
Digital Input-Voltage Low, VIL				0.4	V
Digital Input-Current High, I _{IH}		-1		+1	μA
Digital Input-Current Low, IIL		-1		+1	μA

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

DC Electrical Characteristics (continued)

(MAX2837 evaluation kit: V_{CC} = 2.7V to 3.6V, Rx set to the maximum gain; \overline{CS} = high, RXHP = SCLK = DIN = low, RSSI and clock output buffer are off, no signal at RF inputs, all RF inputs and outputs terminated into 50 Ω , receiver baseband outputs are open; 90mV_{RMS} differential I and Q signals applied to I, Q baseband inputs of transmitter in transmit mode, f_{REF} = 40MHz, registers set to recommended settings and corresponding test mode, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = 2.8V, f_{LO} = 2.5GHz, and T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
LOGIC OUTPUTS: DOUT					
Digital Output-Voltage High, VOH	Sourcing 100µA	V _{CC} - 0.	4		V
Digital Output-Voltage Low, V _{OL}	Sinking 100µA			0.4	V

AC Electrical Characteristics—Rx MODE

(MAX2837 evaluation kit: V_{CC} = 2.8V, f_{RF} = 2.502GHz, f_{LO} = 2.5GHz; receiver baseband I/Q outputs at 90mV_{RMS} (-21dBV), f_{REF} = 40MHz, ENABLE = RXENABLE = \overline{CS} = high, TXENABLE = SCLK = DIN = low, with power matching for the differential RF pins using the typical applications and registers set to default settings and corresponding test mode, T_A = +25°C, unless otherwise noted. Lowpass filter is set to 10MHz RF channel BW. Unmodulated single-tone RF input signal is used, unless otherwise indicated.) (Note 1)

PARAMETER	CONDITIONS			TYP	MAX	UNITS
RECEIVER SECTION: LNA RF IN	PUT TO BASEBAND	I/Q OUTPUTS				•
RF Input Frequency Range			2.3		2.7	GHz
Peak-to-Peak Gain Variation over RF Input Frequency Range	Tested at band edges	s and band center		0.8		dB
RF Input Return Loss	All LNA gain settings			13		dB
Total Valtage Cain	$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$	Maximum gain, B7:B1 = 0000000	90	99		dB
Total Voltage Gain	TA = -40 C 10 +65 C	Minimum gain, B7:B1 = 1111111		5	13	uв
	From max RF gain to	max RF gain - 8dB		8		
RF Gain Steps	From max RF gain to	max RF gain - 16dB		16		dB
	From max RF gain to	max RF gain - 32dB		32		
Coin Change Sottling Time	Any RF or baseband gain change; gain settling to within P1dB of steady state; RXHP = 1			0.2		
Gain Change Settling Time	Any RF or baseband gain change; gain settling to within P0.1dB of steady state; RXHP = 1			2		μs
Baseband Gain Range	From maximum baseband gain (B5:B1 = 00000) to minimum baseband gain (B5:B1 = 11111), T _A = -40°C to +85°C		58	62	66	dB
Baseband Gain Minimum Step Size				2		dB
	Voltage gain R 65dB	with max RF gain (B7:B6 = 00)		2.3		
	Voltage gain = 50dB with max RF gain - 8dB (B7:B6 = 01)			5.5		
DSB Noise Figure	Voltage gain = 45dB with max RF gain - 16dB (B7:B6 = 10)			17		dB
	Voltage gain = 15dB (B7:B6 = 11)	with max RF gain - 32dB		27		

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

AC Electrical Characteristics—Rx MODE (continued)

(MAX2837 evaluation kit: V_{CC} = 2.8V, f_{RF} = 2.502GHz, f_{LO} = 2.5GHz; receiver baseband I/Q outputs at 90mV_{RMS} (-21dBV), f_{REF} = 40MHz, ENABLE = RXENABLE = \overline{CS} = high, TXENABLE = SCLK = DIN = low, with power matching for the differential RF pins using the typical applications and registers set to default settings and corresponding test mode, T_A = +25°C, unless otherwise noted. Lowpass filter is set to 10MHz RF channel BW. Unmodulated single-tone RF input signal is used, unless otherwise indicated.) (Note 1)

PARAMETER	cc	ONDITIONS	MIN	TYP	MAX	UNITS
	Max RF gain (B7:B6 = 00)			-37		
In Dond Innut D 1dD	Max RF gain - 8dB (B7:B6 = 01)			-29		dDm
In-Band Input P-1dB	Max RF gain - 16dB (B7:B	6 = 10)	-21			dBm
	Max RF gain - 32dB (B7:B	6 = 11)		-4		
Maximum Output Signal Level	Over passband frequency compression point	range; at any gain setting; 1dB		2.5		V _{P-P}
	Max RF gain (B7:B6 = 00) wanted signal	, AGC set for -65dBm		-11		
Out-of-Band Input IP3 (Note 2)	Max RF gain - 8dB (B7:B6 wanted signal	= 01), AGC set for -55dBm		-8		dBm
Out-or-band input iF3 (Note 2)	Max RF gain - 16dB (B7:B wanted signal	6 = 10), AGC set for -40dBm		-6		
	Max RF gain - 32dB (B7:B wanted signal	6 = 11), AGC set for -30dBm		+16		
I/Q Phase Error	50kHz baseband output; 1	σ variation		0.15		Degrees
I/Q Gain Imbalance	50kHz baseband output; 1	σ variation		0.1		dB
Rx I/Q Output Load Impedance	Minimum differential resist	ance		10		kΩ
(R C)	Maximum differential capa	citance		5		pF
I/Q Output DC Droop		After switching RXHP to 0; average over 1 μ s after any gain change, or 2 μ s after receive enabled with 100Hz interval AC-coupling, 1 σ variation				mV/ms
I/Q Static DC Offset	No RF input signal; measu RXHP = 1 for 0 to 2μs and 1σ variation	re at 3μs after receive enable; set to 0 after 2μs,		±1		mV
Loopback Gain (for Receiver I/Q Calibration)		ceiver I/Q output; transmitter B6:B1 = 10100 programmed through SPI	-4.5	0	+4.5	dB
RECEIVER BASEBAND FILTERS	5					
	At 15MHz			57		
Baseband Filter Rejection	At 20MHz			75		dB
	At > 40MHz			90		
	RXHP = 1 (used before AGC completion)		650			1
Deschand Linkness Filter Organization	D5:D4 = 00			0.1		
Baseband Highpass Filter Corner Frequency	RXHP = 0 (used after AGC completion) address	D5:D4 = 01	1		kHz	
	AGC completion) address A4:A0 = 01110	D5:D4 = 10		30		
		D5:D4 = 11		100		

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

AC Electrical Characteristics—Rx MODE (continued)

(MAX2837 evaluation kit: V_{CC} = 2.8V, f_{RF} = 2.502GHz, f_{LO} = 2.5GHz; receiver baseband I/Q outputs at 90mV_{RMS} (-21dBV), f_{REF} = 40MHz, ENABLE = RXENABLE = \overline{CS} = high, TXENABLE = SCLK = DIN = low, with power matching for the differential RF pins using the typical applications and registers set to default settings and corresponding test mode, T_A = +25°C, unless otherwise noted. Lowpass filter is set to 10MHz RF channel BW. Unmodulated single-tone RF input signal is used, unless otherwise indicated.) (Note 1)

PARAMETER	C	ONDITIONS	MIN	TYP	MAX	UNITS
	A4:A0 = 00010 serial bits	D7:D4 = 0000		1.75		
	A4:A0 = 00010 serial bits	2.25				
	A4:A0 = 00010 serial bits	D7:D4 = 0010		3.5		
	A4:A0 = 00010 serial bits	D7:D4 = 0011		5.0		
	A4:A0 = 00010 serial bits	D7:D4 = 0100		5.5		
	A4:A0 = 00010 serial bits	D7:D4 = 0101		6.0		
	A4:A0 = 00010 serial bits	D7:D4 = 0110		7.0		
RF Channel BW Supported by	A4:A0 = 00010 serial bits	D7:D4 = 0111		8.0		MHz
Baseband Filter	A4:A0 = 00010 serial bits	D7:D4 = 1000		9.0		
	A4:A0 = 00010 serial bits	D7:D4 = 1001		10.0		
	A4:A0 = 00010 serial bits	D7:D4 = 1010		12.0		
	A4:A0 = 00010 serial bits D7:D4 = 1011			14.0		
	A4:A0 = 00010 serial bits		15.0 20.0 24.0			
	A4:A0 = 00010 serial bits D7:D4 = 1101					
	A4:A0 = 00010 serial bits					
	A4:A0 = 00010 serial bits D7:D4 = 1111			28.0		
Reachand Cain Dinnla	0 to 2.3MHz for BW = 5MHz			1.3		dD
Baseband Gain Ripple	0 to 4.6MHz for BW = 10MHz			1.3		- dB _{P-P}
Reachand Crown Dolay Binnla	0 to 2.3MHz for BW = 5MHz			90		no
Baseband Group Delay Ripple	0 to 4.6MHz for BW = 10MHz			50		ns _{P-P}
Baseband Filter Rejection for	At 3.3MHz			7		dB
5MHz RF Channel BW	At > 21MHz			85		uв
Baseband Filter Rejection for	At 6.7MHz			7		dB
10MHz RF Channel BW	At > 41.6MHz			85		uв
RSSI						
RSSI Minimum Output Voltage	R _{LOAD} ≥ 10kΩ	R _{LOAD} ≥ 10kΩ		0.4		V
RSSI Maximum Output Voltage	R _{LOAD} ≥ 10kΩ		2.2		V	
RSSI Slope				30		mV/dB
RSSI Output Settling Time	To within 3dB of steady	+32dB signal step		200		ne
	state	-32dB signal step		800		ns

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

AC Electrical Characteristics—Tx MODE

(MAX2837 evaluation kit: V_{CC} = 2.8V, T_A = +25°C, f_{RF} = 2.502GHz, f_{LO} = 2.5GHz; f_{REF} = 40MHz, ENABLE = TXENABLE = \overline{CS} = high, and RXENABLE = SCLK = DIN = low, with power matching for the differential RF pins using the *Typical Operating Circuit*. Lowpass filter is set to 10MHz RF channel BW, 90mV_{RMS} sine and cosine signal (or 90mV_{RMS} 64QAM 1024-FFT OFDMA FUSC I/Q signals wherever OFDM is mentioned) applied to baseband I/Q inputs of transmitter (differential DC-coupled).) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
TRANSMIT SECTION: Tx BASEB	AND I/Q INPUTS TO RF OUTPUTS					
RF Output Frequency Range		2.3		2.7	GHz	
Peak-to-Peak Gain Variation over RF Band	Output optimally matched over 200MHz RF BW		2.5		dB	
Total Voltage Gain	Max gain; at unbalanced 50Ω balun output		12		dB	
Maximum Output Power over Frequency for Any Given 200MHz Band	OFDM signal conforming to spectral emission mask and -36dB EVM after I/Q imbalance calibration by modem (Note 3)		0		dBm	
RF Output Return Loss	Given 200MHz band in the 2.3GHz to 2.7GHz range, for which the matching has been optimized		8		dB	
RF Gain Control Range			45		dB	
Unwanted Sideband Suppression	Without calibration by modem, and excludes modem I/Q imbalance; P _{OUT} = 0dBm		45		dBc	
	B1	1				
	B2		2			
RF Gain-Control Binary Weights	B3 B4		4		dB	
The Gain-Control Binary Weights			8			
	B5		16			
	B6		16	-		
Carrier Leakage	Relative to 0dBm output power; without calibration by modem		-35		dBc	
	Minimum differential resistance		100		kΩ	
Tx I/Q Input Impedance (R C)	Maximum differential capacitance		0.5		pF	
Baseband Frequency Response	0 to 2.3MHz		0.2		٩D	
for 5MHz RF Channel BW	At > 25MHz	80		dB		
Baseband Frequency Response	0 to 4.6MHz		0.2		dB	
for 10MHz RF Channel BW	At > 17MHz		80		UD	
Baseband Group Delay Ripple	0 to 2.3MHz (BW = 5MHz)		20			
Dasebailly Group Delay Ripple	0 to 4.6MHz (BW = 10MHz)		12		ns	

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

AC Electrical Characteristics—Frequency Synthesis

(MAX2837 evaluation kit: V_{CC} = 2.8V, f_{LO} = 2.5GHz, f_{REF} = 40MHz, ENABLE = \overline{CS} = high, SCLK = DIN = low, PLL loop bandwidth = 120kHz, T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
FREQUENCY SYNTHESIZER					
RF Channel Center Frequency		2.3		2.7	GHz
Channel Center Frequency Programming Minimum Step Size			20		Hz
Charge-Pump Comparison Frequency		11	40		MHz
Reference Frequency Range		11	40	80	MHz
Reference Frequency Input Levels	AC-coupled to XTAL2 pin	800			mV _{P-P}
Reference Frequency Input	Resistance (XTAL2 pin)		10		kΩ
Impedance (R C)	Capacitance (XTAL2 pin)		1		pF
Programmable Reference Divider Values		1	2	4	
Closed-Loop Integrated Phase Noise	Loop BW = 120kHz; integrate phase noise from 200Hz to 5MHz, charge-pump comparison frequency = 40MHz		-39		dBc
Charge-Pump Output Current	On each differential side		1.6		mA
	f _{OFFSET} = 0 to 1.8MHz		-40		
Close-In Spur Level	f _{OFFSET} = 1.8MHz to 7MHz		-70		dBc
	f _{OFFSET} > 7MHz		-80		
Reference Spur Level			-85		dBc
Turnaround LO Frequency Error	Relative to steady state; measured 35µs after Tx-Rx or Rx-Tx switching instant, and 4µs after any receiver gain changes		±50		Hz
Temperature Range over Which VCO Maintains Lock	Relative to the ambient temperature T_A , as long as the VCO lock temperature range is within operating temperature range		T _A ±40		°C
Reference Output Clock Divider Values		1		2	
Output Clock Drive Level	20MHz output, 1x drive setting		1.5		V _{P-P}
Output Clock Minimum Load	Resistance		10		kΩ
Impedance (R C)	Capacitance 2				pF

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

AC Electrical Characteristics—Miscellaneous Blocks

(MAX2837 evaluation kit: V_{CC} = 2.8V, f_{REF} = 40MHz, ENABLE = \overline{CS} = high, SCLK = DIN = low, T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITION	S	MIN TY	P MAX	UNITS	
PA BIAS DAC: CURRENT MOD	E		· · · ·			
Numbers of Bits			6	Bits		
Minimum Output Sink Current	D5:D0 = 000000 in A4:A0 = 11100		()	μA	
Maximum Output Sink Current	D5:D0 = 111111 in A4:A0 = 11100		31	0	μA	
Compliance Voltage Range			0.8	2.0	V	
Turn-On Time	Excludes programmable delay of 0 of 0.5µs	xcludes programmable delay of 0 to 7µs in steps f 0.5µs			ns	
DNL			1		LSB	
PA BIAS DAC: VOLTAGE MOD	E		÷			
Output High Level	10mA source current		V _{CC}	V		
Output Low Level	10mA sink current		0.	V		
Turn-On Time	Excludes programmable delay of 0 of 0.5µs	Excludes programmable delay of 0 to 7µs in steps of 0.5µs			ns	
CRYSTAL OSCILLATOR	·		· · · ·			
On-Chip Tuning Capacitance	Maximum capacitance, A4:A0 = 110 D6:D0 =1111111	15				
Range	Minimum capacitance, A4:A0 = 110 D6:D0 =0000000	0.	- pF			
On-Chip Tuning Capacitance Step Size			0.	12	pF	
ON-CHIP TEMPERATURE SEN	SOR		· · ·			
		T _A = +25°C	011	111		
Digital Output Code	Read-out at DOUT pin through SPI A4:A0 = 00111, D4:D0	T _A = +85°C	111	11101 00001		
	A4.00	T _A = -40°C	000			

AC Electrical Characteristics—Timing

(MAX2837 evaluation kit: V_{CC} = 2.8V, f_{LO} = 2.5GHz, f_{REF} = 40MHz, ENABLE = \overline{CS} = high, SCLK = DIN = low, PLL loop bandwidth = 120kHz, T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
SYSTEM TIMING								
Turnaround Time	Measured from Tx or Rx enable rising edge;	Rx to Tx	2					
		signal settling to within 0.5dB of steady state	Tx to Rx, RXHP = 1		2		μs	
Tx Turn-On Time (from Standby Mode)		Measured from Tx enable rising edge; signal settling to within 0.5dB of steady state			2		μs	

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

AC Electrical Characteristics—Timing (continued)

(MAX2837 evaluation kit: V_{CC} = 2.8V, f_{LO} = 2.5GHz, f_{REF} = 40MHz, ENABLE = \overline{CS} = high, SCLK = DIN = low, PLL loop bandwidth = 120kHz, T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Tx Turn-Off Time (to Standby Mode)		From Tx enable falling edge		0.1		μs
Rx Turn-On Time (from Standby Mode)		Measured from Rx enable rising edge; signal settling to within 0.5dB of steady state		2		μs
Rx Turn-Off Time (to Standby Mode)		From Rx enable falling edge		0.1		μs
4-WIRE SERIAL-INTERFACE TIM	ING (See Fig	gure 1)				
SCLK Rising Edge to $\overline{\text{CS}}$ Falling Edge Wait Time	tcso			6		ns
Falling Edge of \overline{CS} to Rising Edge of First SCLK Time	t _{CSS}			6		ns
DIN to SCLK Setup Time	t _{DS}			6		ns
DIN to SCLK Hold Time	t _{DH}			6		ns
SCLK Pulse-Width High	tсн			6		ns
SCLK Pulse-Width Low	t _{CL}			6		ns
Last Rising Edge of SCLK to Rising Edge of CS or Clock to Load Enable Setup Time	^t сsн			6		ns
CS High Pulse Width	tcsw			20		ns
Time Between Rising Edge of CS and the Next Rising Edge of SCLK	t _{CS1}			6		ns
Clock Frequency	fCLK				45	MHz
Rise Time	t _R		f	_{CLK} / 10		ns
Fall Time	t _F		f	_{CLK} / 10		ns
SCLK Falling Edge to Valid DOUT	t _D			12.5		ns

Note 1: Min and max limits guaranteed by test above $T_A = +25^{\circ}C$ and guaranteed by design and characterization at $T_A = -40^{\circ}C$. The power-on register settings are not production tested. Recommended register setting must be loaded after V_{CC} is supplied.

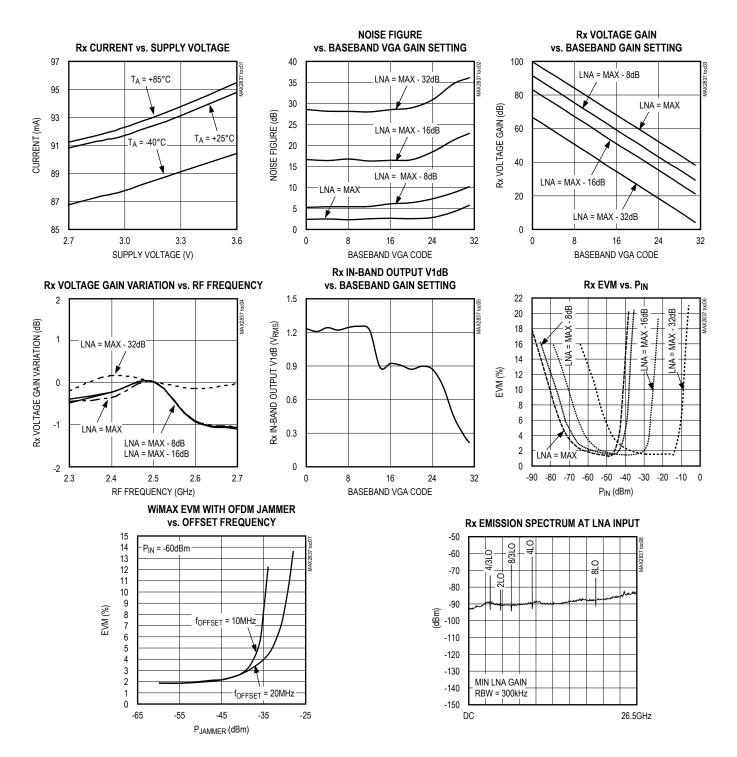
Note 2: Two tones at +25MHz and +39MHz offset with -35dBm/tone. Measure IM3 at 1MHz.

Note 3: Gain adjusted over max gain and max gain - 3dB. Optimally matched over given 200MHz band.

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Typical Operating Characteristics

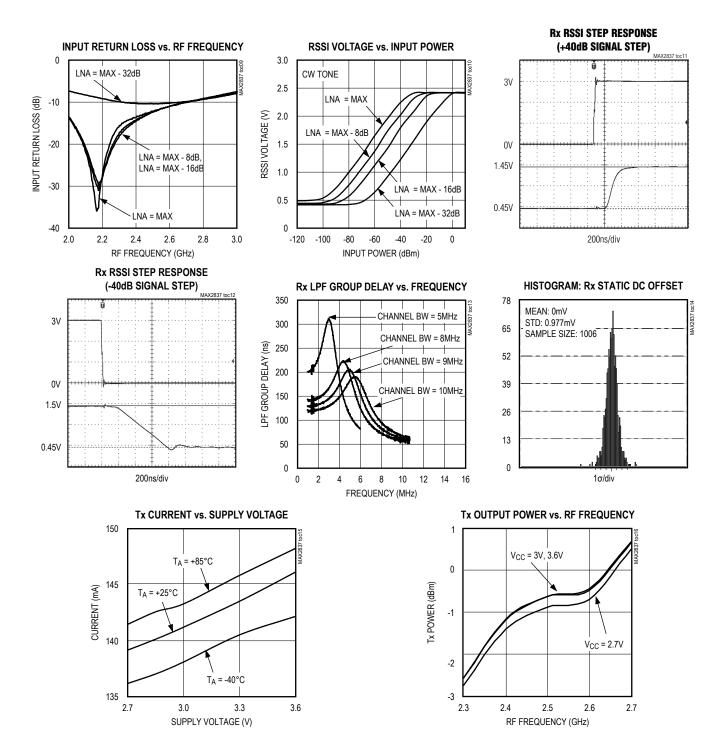
(MAX2837 evaluation kit: V_{CC} = 2.8V, f_{LO} = 2.5GHz, 10MHz channel 16E UL/DL WiMax signal, f_{REF} = 40MHz, ENABLE = \overline{CS} = high, RXHP = SCLK = DIN = low, T_A = +25°C, unless otherwise noted.)



2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Typical Operating Characteristics (continued)

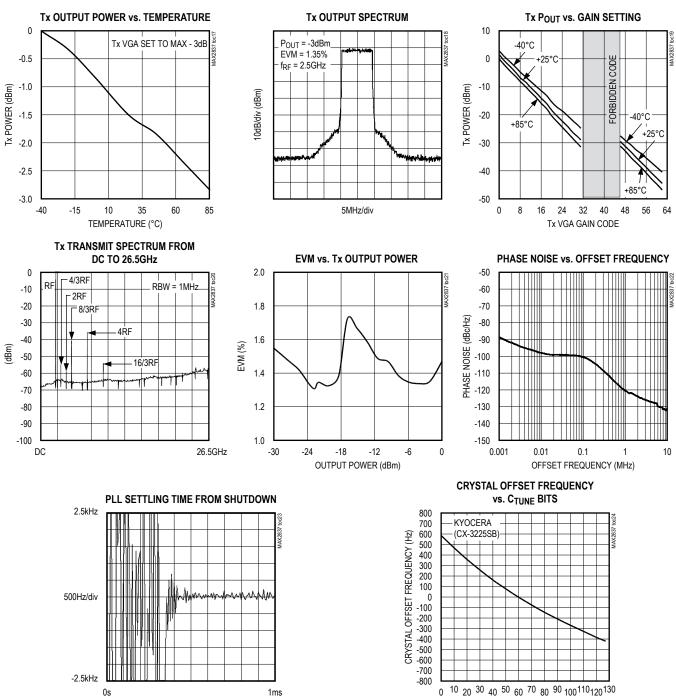
(MAX2837 evaluation kit: V_{CC} = 2.8V, f_{LO} = 2.5GHz, 10MHz channel 16E UL/DL WiMax signal, f_{REF} = 40MHz, ENABLE = \overline{CS} = high, RXHP = SCLK = DIN = low, T_A = +25°C, unless otherwise noted.)



2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Typical Operating Characteristics (continued)

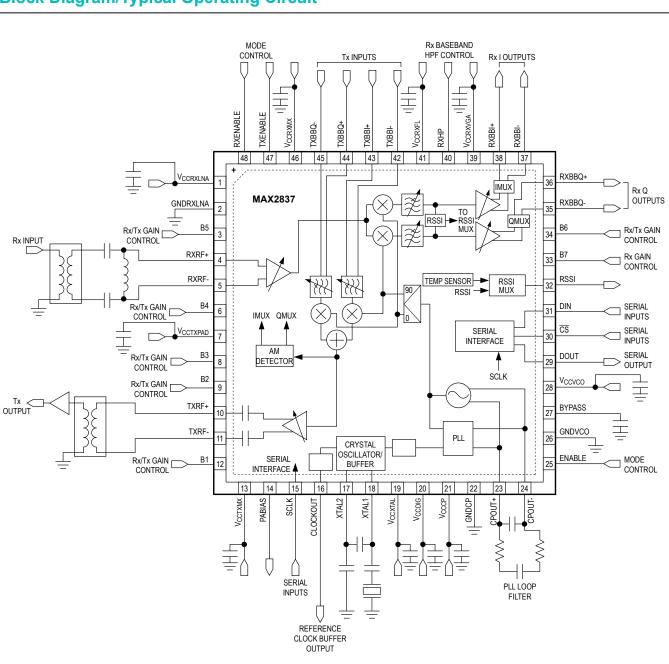
(MAX2837 evaluation kit: V_{CC} = 2.8V, f_{LO} = 2.5GHz, 10MHz channel 16E UL/DL WiMax signal, f_{REF} = 40MHz, ENABLE = \overline{CS} = high, RXHP = SCLK = DIN = low, T_A = +25°C, unless otherwise noted.)





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2.3GHz to 2.7GHz Wireless Broadband RF Transceiver



Block Diagram/Typical Operating Circuit

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Pin Description

PIN	NAME	FUNCTION
1	V _{CCRXLNA}	LNA Supply Voltage. Bypass with a capacitor as close as possible to the pin.
2	GNDRXLNA	LNA Ground
3	B5	Receiver and Transmitter Gain-Control Logic Input Bit 5
4	RXRF+	LNA Differential Inputs. Inputs are internally DC-coupled. An external shunt inductor and series
5	RXRF-	capacitors match the inputs to 100Ω differential.
6	B4	Receiver and Transmitter Gain-Control Logic Input Bit 4
7	VCCTXPAD	Supply Voltage for Power-Amplifier Driver. Bypass with a capacitor as close as possible to the pin.
8	B3	Receiver and Transmitter Gain-Control Logic Input Bit 3
9	B2	Receiver and Transmitter Gain-Control Logic Input Bit 2
10	TXRF+	Power-Amplifier Driver Differential Output. PA driver output is internally matched to a 100I differential.
11	TXRF-	The pins have internal DC-blocking capacitors.
12	B1	Receiver and Transmitter Gain-Control Logic Input Bit 1
13	V _{CCTXMX}	Transmitter Upconverter Supply Voltage. Bypass with a capacitor as close as possible to the pin.
14	PABIAS	Transmit PA Bias DAC Output
15	SCLK	Serial-Clock Logic Input of 4-Wire Serial Interface (See Figure 1)
16	CLOCKOUT	Reference Clock Buffer Output
17	XTAL2	Crystal or Reference Clock Input. AC-couple a crystal or a reference clock to this analog input.
18	XTAL1	Connection for Crystal-Oscillator Off-Chip Capacitors. When using an external reference clock input, leave XTAL1 unconnected.
19	V _{CCXTAL}	Crystal-Oscillator Supply Voltage. Bypass with a capacitor as close as possible to the pin.
20	V _{CCDIG}	Digital Circuit Supply Voltage. Bypass with a capacitor as close as possible to the pin.
21	V _{CCCP}	PLL Charge-Pump Supply Voltage. Bypass with a capacitor as close as possible to the pin.
22	GNDCP	Charge-Pump Circuit Ground
23	CPOUT+	Differential Charge-Pump Output. Connect the frequency synthesizer's loop filter between CPOUT+
24	CPOUT-	and CPOUT (See the Typical Operating Circuit.)
25	ENABLE	Operation Mode Logic Input. See Table 1 for operating modes.
26	GNDVCO	VCO Ground
27	BYPASS	On-Chip VCO Regulator Output Bypass. Bypass with a 1µF capacitor to GND. Do not connect other circuitry to this point.
28	V _{CCVCO}	VCO Supply Voltage. Bypass with a capacitor as close as possible to the pin.
29	DOUT	Data Logic Output of 4-Wire Serial Interface (See Figure 1)
30	CS	Chip-Select Logic Input of 4-Wire Serial Interface (See Figure 1)
31	DIN	Data Logic Input of 4-Wire Serial Interface (See Figure 1)
32	RSSI	RSSI or Temperature Sensor Multiplexed Analog Output
33	B7	Receiver Gain-Control Logic Input Bit 7
34	B6	Receiver and Transmitter Gain-Control Logic Input Bit 6
35	RXBBQ-	Receiver Baseband Q-Channel Differential Outputs. In Tx calibration mode, these pins are the
36	RXBBQ+	LO leakage and sideband detector outputs.
37	RXBBI-	Receiver Baseband I-Channel Differential Outputs. In Tx calibration mode, these pins are the
38	RXBBI+	LO leakage and sideband detector outputs.
39	V _{CCRXVGA}	Receiver VGA Supply Voltage
40	RXHP	Receiver Baseband AC-Coupling Highpass Corner Frequency Control Logic Input
41	V _{CCRXFL}	Receiver Baseband Filter Supply Voltage

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Pin Description (continued)

PIN	NAME	FUNCTION	
42	TXBBI-	Transmitter Reschand I Channel Differential Inputs	
43	TXBBI+	Transmitter Baseband I-Channel Differential Inputs	
44	TXBBQ+	Transmitter Reschand O. Channel Differential Inputs	
45	TXBBQ-	Transmitter Baseband Q-Channel Differential Inputs	
46	V _{CCRXMX}	Receiver Downconverters Supply Voltage. Bypass with a capacitor as close as possible to the pin.	
47	TXENABLE	Tx Mode Control Logic Input. See Table 1 for operating modes.	
48	RXENABLE	Rx Mode Control Logic Input. See Table 1 for operating modes.	
EP	EP	Exposed Paddle. Connect to the ground plane with multiple vias for proper operation and heat dissipation. Do not share with any other pin grounds and bypass capacitors' ground.	

Table 1. Operating Mode Table

MODE	LOGIC PINS									
MODE	ENABLE	RXENABLE	TXENABLE		D1:D0 A4:A0 = 10000		Tx PATH	PLL, VCO, LO GEN	CALIBRATION SECTIONS ON	CLOCK OUT
Clock-Out	1	0	0	0	0	Off	Off	Off	None	On
Shutdown	0	0	0	0	Х	Off	Off	Off	None	Off
Standby	1	0	0	0	1	Off*	Off*	On	None	On
Rx	1	1	0	0	1	On	Off	On	None	On
Тх	1	0	1	0	1	Off	On	On	None	On
Rx Calibration	1	1	0	1	1	On (Except LNA)	Off (Except Upconverters)	On	Tx Baseband Buffer	On
Tx Calibration	1	0	1	1	1	Off	On (Except PA Driver)	On	AM Detector, Rx I/Q Buffers	On

*Blocks of the transceiver can be selectively enabled through SPI.

Detailed Description

Modes of Operation

The modes of operation for the MAX2837 are clock-out, shutdown, transmit, receive, transmitter calibration, and receiver calibration. See Table 1 for a summary of the modes of operation. The logic input pins—ENABLE (pin 25), TXENABLE (pin 47), and RXENABLE (pin 48)—control the various modes. When the parts are active, various blocks can be shut down individually through SPI.

Shutdown Mode

The MAX2837 features a low-power shutdown mode. Current drain is the minimum possible with the supply voltages applied. In shutdown mode, all circuit blocks are powered down, except the 4-wire serial bus and its internal programmable registers. If the supply voltage is applied, the registers are loaded and retained.

Standby Mode

The standby mode is used to enable the frequency synthesizer block while the rest of the device is powered down. In this mode, PLL, VCO, and LO generator are on, so that Tx or Rx modes can be quickly enabled from this mode. These and other blocks can be selectively enabled in this mode.

Receive (Rx) Mode

In receive mode, all Rx circuit blocks are powered on and active. Antenna signal is applied; RF is downconverted, filtered, and buffered at Rx BB I and Q outputs. The slow-charging Tx circuits are in a precharged "idle-off" state for fast Rx-to-Tx turnaround time.

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

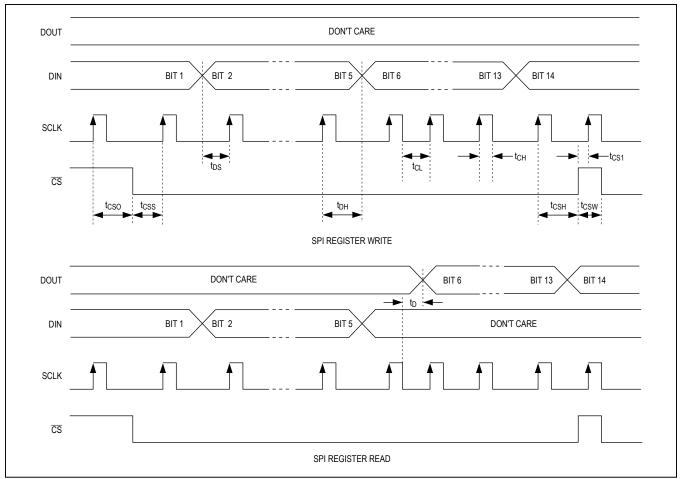


Figure 1. 4-Wire SPI Serial-Interface Timing Diagram

Transmit (Tx) Mode

In transmit mode, all Tx circuit blocks are powered on. The external PA is powered on after a programmable delay using the on-chip PA bias DAC. The slow-charging Rx circuits are in a precharged "idle-off" state for fast Tx-to-Rx turnaround time.

Clock-Out Only

In clock-out mode, the entire transceiver is off except the divided reference clock output on the CLKOUT pin and the clock divider, which remains on.

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Temperature Sensor Readout Through DOUT Pin

To estimate chip temperature, on-chip temperature sensor is enabled by programming Address 9 D<1> = 1. The procedure is as follows:

- Enable temp-sensor by setting Address 9 D<1> = 1. Roughly 100µs to 1ms time is needed to let the temperature sensor output settle to within 5 to 1 degrees.
- 2) To trigger temperature sensor ADC, program Address 9 D<0> from "0" to "1". The ADC will acquire the 5-bit logic output in 2µs, temperature sensor needs to be ON (Address 9 D<1> = 1) to maintain the ADC logic output. Note that the ADC trigger should happen AFTER the temp sensor is enabled to get the correct result. Therefore, step 1 and step 2 of this procedure should be carried out on two separate SPI programming events separated by the temp sensor settling time.
- Note that after the ADC latches its output and you desire to retake another temp sensor temperature reading value, the ADC has to be retriggered to reacquire a new temp sensor value (assuming the temp sensor is already enabled). To do so, program Address 9 D<0> from "1" to "0" then from "0" to "1". After the ADC latches it digital output in 2µs it shuts off.
- To read the 5-bit logic output through DOUT pin, apply 4-wire SPI readout programming sequence to Address 7.

VAS Operating Procedure

After power-up, program Address 22 D<1> = 0 such that VAS frequency acquisition starts from VCO band 15, it reduces the worst-case acquisition time by half. VAS acquisition starts after Address 17 is programmed (i.e. rising edge of CSB), it takes the worst-case 896 μ s to acquire lock.

Wireless LAN or MAN systems do not switch channel frequency often, die temperature may change quite a bit over time and makes PLL out of lock. To relock PLL as soon as possible, the user can program Address 22 D<1> = 1 after the first power-up frequency acquisition. VAS starts from the previous frequency subband and should relock PLL within 112µs.

VAS Readout

The selected VCO subband, Vtune ADC output and VAS accomplished (VASA) signal can be read out through DOUT pin by programming Address 9 D<7:5> = 010 and corresponding Address 26 D<9:6>.

VCO Subband Selection Through SPI

For very fast band selection operation, the user can characterize the mapping between VCO frequencies and corresponding subbands during factory calibration. After programming Address 22 D<0> = 0, the VCO subband can be selected by Address 23 D<4:0>.

Programmable Registers and 4-Wire SPI Interface

The MAX2837 includes 32 programmable 16-bit registers. The most significant bit (MSB) is the read/write selection bit. The next 5 bits are register address. The 10 least significant bits (LSBs) are register data. Register data is loaded through the 4-wire SPI/MICROWIRE®-compatible serial interface. Data at DIN is shifted in MSB first and is framed by \overline{CS} . When \overline{CS} is low, the clock is active, and input data is shifted at the rising edge of the clock. During the read mode, register data selected by address bits is shifted out to DOUT at the falling edges of the clock. At the \overline{CS} rising edge, the 10-bit data bits are latched into the register selected by address bits. See Figure 1. The register values are preserved in shutdown mode as long as the power-supply voltage is maintained. However, every time the power-supply voltage is turned on, the registers are reset to the default values. Note that default register states are not guaranteed, and the user should always reprogram all registers after power-up.

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2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

ADDRESS	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	HEX
0	0	1	0	1	0	1	0	0	0	0	150
1	0	0	0	0	0	0	0	0	1	0	002
2	0	1	1	1	1	1	0	1	0	0	1F4
3	0	1	1	0	1	1	1	0	0	1	1B9
4	0	0	0	0	0	0	1	0	1	0	00A
5	0	0	1	0	0	0	0	0	0	0	080
6	0	0	0	0	0	0	0	1	1	0	006
7	0	0	0	0	0	0	0	0	0	0	000
8	0	0	1	0	0	0	0	0	0	0	080
9	0	0	0	0	0	1	1	0	0	0	018
10	0	0	0	1	0	1	1	0	0	0	058
11	0	0	0	0	0	1	0	1	1	0	016
12	1	0	0	1	0	0	1	1	1	1	24F
13	0	1	0	1	0	1	0	0	0	0	150
14	0	1	1	1	0	0	0	1	0	1	1C5
15	0	0	1	0	0	0	0	0	0	1	081
16	0	0	0	0	0	1	1	1	0	0	01C
17	0	1	0	1	0	1	0	1	0	1	155
18	0	1	0	1	0	1	0	1	0	1	155
19	0	1	0	1	0	1	0	0	1	1	153
20	1	0	0	1	0	0	0	0	0	1	241
21	0	0	0	0	1	0	1	1	0	1	02D
22	0	1	1	0	1	0	1	0	0	1	1A9
23	1	0	0	1	0	0	1	1	1	1	24F
24	0	1	1	0	0	0	0	0	0	0	180
25	0	1	0	0	0	0	0	0	0	0	100
26	1	1	1	1	0	0	1	0	1	0	3CA
27	1	1	1	1	1	0	0	0	1	1	3E3
28	0	0	1	1	0	0	0	0	0	0	0C0
29	1	1	1	1	1	1	0	0	0	0	3F0
30	0	0	1	0	0	0	0	0	0	0	080
31	0	0	0	0	0	0	0	0	0	0	000

Table 2. Recommended Register Settings

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 3. Address 0, RXRF Register 1 (Default = 150_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9	0	Sets the center frequency of LNA output LC tank. 0 = Band 2.3~2.5GHz 1 = Band 2.5~2.7GHz
D8:D3	101010	Set to recommended value.
D2	0	Enables RX quadrature generation, except for shut down mode. 1 = Enable 0 = Disabled
D1	0	Enables RX Mixer, except for shut down mode. 1 = Enable 0 = Disabled
D0	0	Enables LNA, except for shut down mode. 1 = Enable 0 = Disabled

Table 4. Address 1, RXRF Register 2 (Default = 002_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D5	00000	RX LO IQ calibration SPI control. Active when Address 8 D<9> = 1. Serves as trim word of fuse links independent of Address 8 D<9>. 00000 = +4.0° phase error (default) (Q lags I signal by 94°). 01111 = 0.0° phase error. 11111 = -4.0° deg phase error (Q lags I signal by 86°).
D4:D2	000	Adjusts the LNA gain by SPI. Active when Address 8 D<0> = 1. 000 = MAX gain (default) 100 = MAX-8dB 010 = MAX-16dB 110 = MAX-24dB 011 = MAX-32dB 111 = MAX-40dB
D1	1	LNA output tank de_Q resistance tuning in 'Down' process. 0 = Nominal 1 = Increase ~2dB gain in down process (default)
D0	0	LNA output LC tank center frequency tuning in 'Down' process. 0 = Nominal (default) 1 = Down process

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 5. Address 2, LPF Register 1 (Default = 1F4_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D8	01	Fine-tune the LPF cutoff frequency. 00 = -10% 01 = Nominal (default) 10 = Nominal 11 = +10%
D7:D4	1111	Sets the LPF RF Bandwidth. 0000 = 1.75MHz 0001 = 2.5MHz 0010 = 3.5MHz 0011 = 5.0MHz 0100 = 5.5MHz 0101 = 6.0MHz 0110 = 7.0MHz 1011 = 8.0MHz 1000 = 9.0MHz 1001 = 10.0MHz 1010 = 12.0MHz 1011 = 14.0MHz 1100 = 15.0MHz 1110 = 24.0MHz 1111 = 28.0MHz (default)
D3:D2	01	Sets the mode of the lowpass filter block. Active when Address 6 D<9> = 1. 00 = Rx Calibration 01 = Rx LPF (default) 10 = Tx LPF 11 = LPF Trim
D1	0	Enables the TX input buffer, except for shutdown mode. 1 = Enabled 0 = Disabled
D0	0	Enables the lowpass filter, except for shutdown mode. 1 = Enabled 0 = Disabled

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

DATA BITS	DEFAULT	DESCRIPTION
D9:D7	011	Tx output (real pole) common-mode voltage adjustment. 000 = 1.00 V 001 = 1.05 010 = 1.10 011 = 1.15 (default) 100 = 1.20 101 = 1.25 110 = 1.30 111 = Not allowed
D6:D0	0111001	Set to recommended value.

Table 6. Address 3, LPF Register 2 (Default = 1B9_{HEX})

Table 7. Address 4, LPF Register 3 and VGA Register 1 (Default = 00A_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D8	00	Sets the RX VGA output common-mode voltage. 00 = 0.9V (default) 01 = 1.0V 10 = 1.1V 11 = 1.25V
D7:D6	00	Set to recommended value.
D5	0	RXVGA output MUX and buffer enable, except for shutdown mode. 1 = Enable 0 = Disabled
D4	0	Enables RxVGA, except for shutdown mode. 1 = Enable 0 = Disabled
D3:D0	1010	Set to recommended value.

Table 8. Address 5, VGA Register 2 (Default = 080_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D6	0010	Set to recommended value.
D5	0	 RX baseband output select. Used to select RX mode and TX calibration mode output. 0 = RXVGA (default) 1 = TX AM detector for TX calibration mode.
D4:D0	00000	Sets attenuation in the RxVGA. Active when Address 8 D<1 > = 1. 00000 = MAX gain (default) 00001 = MAX - 2dB 11111 = MIN gain

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 9. Address 6, VGA Register 3 and RX_TOP SPI bits (Default = 006_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9	0	LPF mode mux, LPF_MODE_SEL = 1. 0 = Normal operation 1 = Operating mode is programmed Address 2 D3:D2
D8	0	RSSI operating mode during RX mode. 0 = Off when RXHP = 0 1 = Independent of RXHP
D7	0	RSSI pin output MUX. 0 = Select RSSI 1 = Select Temperature sensor.
D6	0	RSSI enable, except in shutdown mode. 0 = Disable RSSI 1 = Enable RSSI.
D5:D0	000110	Set to recommended value.

Table 10. Address 7, Temperature Sensor 5 bit ADC outputs (Default = 000_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D5	00000	Set to Zeros
D4:D0	00000	Directly connected to Temp Sensor ADC's 5 bit outputs, can be read out by selecting RD_ ENABLE for this register. See the Temperature Sensor Readout Through DOUT Pin section in the Detailed Description.

Table 11. Address 8, RX_TOP SPI bits and RX_BIAS SPI (Default = 080_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9	0	RX IQ calibration DAC MUX between trim word and SPI.0 = Select mux trim word1 = Select mux SPI
D8:D2	0100000	Set to recommended value.
D1	0	Mux VGA gain control bits from SPI. 0 = VGA gain to be controlled by external pins. 1= VGA gain to be controlled by SPI.
D0	0	Mux LNA gain control bits from SPI. 0 = LNA gain to be controlled by external pins. 1 = LNA gain to be controlled by SPI

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 12. Address 9, RX_TOP SPI bits (Default = 018_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D8	00	Set to recommended value.
D7:D5	00	DOUT pin output MUX select. 000 = SPI output (default) 001 = PLL lock detect and test output by Address 21 D9:D7. Set Address 21 D9:D7 = 000 for lock detect output.
D4	1	DOUT pin pullup enable. 0 = Open drain 1 = CMOS (default)
D3	1	DOUT pin output drive select. 0 = 1x (dly<4.4ns) 1 = 4x (dly<3.1ns, default)
D2	0	Set to recommended value.
D1	0	Temp sensor comparator and clock enable. 0 = Disable (default) 1 = Enable
D0	0	Temp sensor ADC trigger. 0 = Not trigger ADC readout 1 = Trigger ADC readout, ADC is disabled automatically after readout finishes. See the <i>Temperature Sensor Readout Through DOUT Pin</i> section in the Detailed Description.

Table 13. Address 10, TX_TOP SPI register 1 (Default = 058_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D6	0001	Set to recommended value.
D5:D3	011	Adjust the bandwidth of TX AM detector baseband filter. 000 = Default +12% 011 = Default bandwidth 111 = Default – 16%
D2:D1	00	TX AM detector baseband gain control. 00 = Default minimum gain 01 = +10dB 10 = +20dB 11 = +30dB
D0	0	Set to recommended value.

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 14. Address 11, TX_TOP SPI register 2 (Default = 016_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D0	0	AM detector SPI enable. 0 = Disable AM detector 1 = Enable AM detector in all modes except shutdown.
D4:D1	1011	Sets the TX mixer V2I gain. 0000 = MAX gain 0001 = MAX gain - 0.5dB 1011 = MAX gain - 5.5dB (default) 1111 = MAX gain - 7.5dB
D0	0	Set to recommended value.

Table 15. Address 12, HPFSM register 1 bits (Default = 24F_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D7	100	Sets the RXVGA 600kHz highpass corner duration triggered by B7 and B6 switching. $000 = 0\mu s$ $001 = 0.8\mu s$ $010 = 1.6\mu s$ $011 = 2.4\mu s$ $100 = 3.2\mu s$ (default) $101 = 4.0\mu s$ $110 = 4.8\mu s$ 111 = stay "1"
D6:D4	100	Sets the RXVGA 600kHz highpass corner duration triggered by RXEN rising edge. $000 = 0\mu s$ $001 = 0.8\mu s$ $010 = 1.6\mu s$ $011 = 2.4\mu s$ $100 = 3.2\mu s$ (default) $101 = 4.0\mu s$ $110 = 4.8\mu s$ 111 = stay "1"
D3:D2	11	Sets the RXVGA 10MHz highpass corner duration triggered by B7 and B6 switching. 00 = 0µs 01 = 0.4µs 10 = 0.8µs 11 = 1.2µs (default)
D1:D0	11	Sets the RXVGA 10MHz highpass corner duration triggered by RXEN rising edge. 00 = 0µs 01 = 0.4µs 10 = 0.8µs 11 = 1.2µs (default)

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 16. Address 13, HPFSM register 2 bits (Default = 150_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D7	100	Sets the RXVGA 600kHz highpass corner duration triggered by B7 and B6 switching. $000 = 0\mu s$ $001 = 0.8\mu s$ $010 = 1.6\mu s$ $011 = 2.4\mu s$ $100 = 3.2\mu s$ (default) $101 = 4.0\mu s$ $110 = 4.8\mu s$ 111 = stay "1"
D6:D4	100	Sets the RXVGA 600kHz highpass corner duration triggered by RXEN rising edge. 000 = 0µs 001 = 0.8µs 010 = 1.6µs 011 = 2.4µs 100 = 3.2µs (default) 101 = 4.0µs 110 = 4.8µs 111 = stay "1"
D3:D2	11	Sets the RXVGA 10MHz highpass corner duration triggered by B7 and B6 switching. 00 = 0µs 01 = 0.4µs 10 = 0.8µs 11 = 1.2µs (default)
D1:D0	11	Sets the RXVGA 10MHz highpass corner duration triggered by RXEN rising edge. 00 = 0µs 01 = 0.4µs 10 = 0.8µs 11 = 1.2µs (default)

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 17. Address 14, HPFSM register 3 bits (Default = 1C5_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9	0	Selects the RXVGA HPFSM operating mode. 0 = Mode #1 1 = Mode #2 which makes use of pin RXHP.
D8	1	RXVGA HPFSM retriggered by B7 and B6. 0 = Disable 1 = Enable (default)
D7:D6	11	RXVGA highpass corner on-hold selection only during MODE2 when RXHP = 1. 00 = 1kHz 01 = 30kHz 10 = 100kHz 11 = 600kHz (default)
D5:D4	00	Selects the RXVGA final highpass corner. 00 = 100Hz (default) 01 = 1kHz 10 = 30kHz 11 = 100kHz
D3:D2	01	Sets the RXVGA HPCa and HPCd rising edge delay for 100kHz/30kHz/1kHz/100Hz highpass corner. 00 = 0µs 01 = 0.2µs (default) 10 = 0.4µs 11 = 0.6µs
D1:D0	01	RXVGA 1kHz highpass corner duration triggered by B7 and B6 switching. 00 = 0μs 01 = 3.2μs (default) 10 = 6.4μs 11 = 9.6μs

Table 18. Address 15, HPFSM Register 4 Bits (Default = 081_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D8	00	Set to recommended value.
D7	1	Controls DOUT three-state to be dependent on CSB. 1 = Dout is three-state when CSB is Hi (default) 0 = Dout is not three-state and is independent on CSB
D6	0	Sequence bypass during RXHP 1>0 transition. 0 = Switch from HPC_STOP_M2<1:0> and programmed sequence (default) 1 = Switch from HPC_STOP_M2<1:0> directly to HPC_STOP<1:0>
D5:D0	000001	Set to recommended value.

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 19. Address 16, Building Block SPI Enable Control (Default = 01C_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9	0	TX LO I/Q Divider Enable. Enable TX LO divide-by-2 divider except for shutdown. 0 = Disable 1 = Enable
D8	0	TX Mixer SPI Enable. Enable TX Mixer in all modes except shutdown. 0 = Disable 1 = Enable
D7	0	PA Bias DAC TX Mode Enable. Enable PA Bias DAC only in TX mode. Turn-on delay is controlled by Address 27 D9:D6. 0 = Disable (default) 1 = Enable when pin TXENABLE = 1
D6	0	PA Bias DAC SPI Enable. Enable PA Bias DAC in all modes except for shutdown. The turn-on delay is controlled by Address 27 D9:D6. 0 = Disable (default) 1 = Enable except during shutdown mode
D5	0	PA Driver SPI Enable. Enable PA Driver in all modes except shutdown. 0 = Enable by pin combination (default) 1 = Enable except shutdown mode
D3	1	Synthesizer SPI Enable. Enable and disable PLL in all modes except shutdown. Independent of RXEN and TXEN pins. 0 = Disable 1 = Enable except shutdown mode (default)
D2	1	LOGEN SPI Enable. Enable LOGEN in all modes except for shutdown. 0 = Enable by pin combination 1 = Enable except shutdown mode (default)
D1	0	RX/TX Calibration Mode Enable. RX or TX mode is selected by pin RXEN or TXEN. 0 = Normal operation (default) 1 = Calibration mode
D0	0	Chip Enable Bit. Logic AND with pin ENABLE to enable/disable the whole chip except crystal oscillator and CLKOUT pin buffer. 0 = Disable (default) 1 = Enable

Table 20. Address 17, Synthesizer Fractional Divide Ratio #1 (Default = 155_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D9	0101010101	Synthesizer 20-bit Fractional Divide Ratio Bit<9:0>, combine with Address 18 D9:D0 to form the whole fractional word. Default = 0101010101

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 21. Address 18, Synthesizer Fractional Divide Ratio #2 (Default = 155_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D9	0101010101	Synthesizer 20-bit Fractional Divide Ratio Bit<19:10>, combine with Address 17 D<9:0> to form the whole fractional word. Default = 0101010101

Table 22. Address 19, Synthesizer Integer Divide Ratio (Default = 153_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D8	01	Sets the LO Generation Band Switch Control for Optimal TX Spur. 00 = 2300~2399.99MHz 01 = 2400~2499.99MHz (default) 10 = 2500~2599.99MHz 11 = 2600~2700MHz
D7:D0	1010011	Synthesizer 8-Bit Integer Divide Ratio. Default = 01010011

Table 23. Address 20, Synthesizer Configuration#1 (Default = 241_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D7	100	Set to recommended value.
D6	1	Synthesizer Turbo Mode Enable. 0 = Disable 1 = Enable.
D5	0	CLOCKOUT Buffer Drive. 0 = 1x drive (default) 1 = 4x drive
D4:D3	00	Selects the Charge-Pump Current. 00 = 3.2mA diff. CP (default) 01 = 1.6mA diff. CP 10 = 1.6mA single-ended CP 11 = 0.8mA single-ended CP
D2:D1	00	Sets the Reference Divider Ratio. 00 = Divide-by-1 (default) 01 = Divide-by-2 10 = Divide-by-4 11 = Divide-by-8
D0	1	Fractional-N PLL Mode Enable. 1 = Enable the fractional-N PLL 0 = Enable the integer-N PLL.

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 24. Address 21, Synthesizer Configuration#2 (Default = 02D_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D7	000	Synthesizer Test Output Select. D<9> = 1 programs charge pump into test mode. D<8:7> decide which PLL test signal is delivered to DOUT MUX and finally selected by Address 9 D<7:5>. 000 = Lock detect (default) 001 = Sigma-delta modulator TVM output 010 = Reference-divider output 011 = Main divider output 100 = CP in low-Z mode and select lock detect 101 = CP in source mode and select sigma-delta modulator 110 = CP in sink mode and select reference-divider output 111 = CP in high-Z mode and select main divider output (used for VCO frequency estimation)
D6:D5	01	Charge-Pump Linearity Current Select. 00 = Disable 01 = +3% (default) 10 = +9% 11 = +12%
D4:D0	01101	Set to recommended value.

Table 25. Address 22, VCO Auto-Select (VAS) Configuration (Default = 1A9_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D8	01	Set to recommended value.
D7	1	VAS Triggering by Address 17 Enable. See Address 17 definitions for details. 0 = Disable for small frequency adjustment (i.e.~100kHz). 1 = Enable for channel switching (default)
D6:D2	01010	Set to recommended value.
D1	0	VAS Relock Mode Select. 0 = Relock starting at sub-band selected by Address 23 D4:D0 (default) 1 = Relock starting at present acquired sub-band.
D0	1	VAS Operating Mode Select. 0 = Select VCO subband by SPI Address 23 D<4:0> (VAS_SPI<4:0>) 1 = Select VCO subband by VAS (default)

Table 26. Address 23, LO Miscellaneous Configuration (Default = 24F_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9	1	VCO SPI Enable. Enable VCO except shutdown mode. 0 = Disable 1 = Enable
D8:D5	0010	Set to recommended value.
D4:D0	01111	VAS Sub-band SPI Overwrite. Active when Address 22 D0 (VAS_MODE) = 0. 00000 = Minimum frequency 01111 = 15 (default) 11111 = Maximum frequency

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 27. Address 24, Crystal Oscillator Configuration (Default = 180_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9	0	Crystal Oscillator Core Enable. Enable except shutdown mode. 0 = Disable (default) 1 = Enable
D8	1	Sets the CLKOUT Divide Ratio. 0 = Divide-by-1 1 = Divide-by-2 (default)
D7	1	CLKOUT Pin Enable. 0 = Disable 1 = Enable (default)
D6:D0	000000	Crystal Oscillator Frequency Tuning. 000000 = Maximum frequency (default) 111111 = Minimum frequency

Table 28. Address 25, Voltage Controlled Oscillator (VCO) Configuration (Default = 100_{HEX)}

DATA BITS	DEFAULT	DESCRIPTION
D9:D8	01	VCO Buffer Bias Control. $00 = 800\mu A$ $01 = 1200\mu A$ (default) $10 = 1600\mu A$ $11 = 2000\mu A$
D7:D5	000	Set to recommended value.
D4:D1	0000	VCO Bias Trim SPI Code. Active when Address 25 D<0> (VCO_BIAS_SPI_EN) = 1. Trim word for VCO bias trim. 0000 = Minimum bias (default) 1000 = Nominal process 1111 = Maximum bias
D0	0	VCO Bias Trim SPI Overwrite Enable. 0 = By trim block (default) 1 = By SPI

Table 29. Address 26, LO Generation (LOGEN) Configuration (Default = 3CA_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D0	1111001010	Set to recommended value.

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 30. Address 27, PA Driver and PA Bias DAC (PADRV and PADAC) Configuration (Default = 3E3_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9	1	TX DC Offset Correction. 0 = Disable 1 = Enable
D8	1	PA DRV/DAC On/Off Gating by VAS TXOOL and PLL LD. 0 = Independent of TXOOL and LD 1 = Relock when TXOOL = 1 or LD = 0 (default)
D7	1	Set to recommended value.
D6	1	PA DAC Voltage-Mode Output Select. Active when Address 27 D5 (PADAC_IV) = 0. 0 = Logic "0" output 1 = Logic "1" output (default)
D5	1	PA DAC I/V Output Select. 0 = Select voltage output 1 = Select current output.
D4:D3	10	Set to recommended value.
D2:D0	011	PA Driver Bias Control. 000 = Minimum 011 = Default 111 = Maximum

Table 31. Address 28, PA Bias DAC (PADAC) Configuration (Default = 0C0_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D6	0011	PADAC Turn-On Delay Control. 0000 = 0μs 0001 = 0μs 0010 = 0.5μs 0011 = 1.0μs (default) 1111 = 7.0μs
D5:D0	000000	PADAC Output Current Control. Active when Address 27 D5 = 1 (PADAC_IV). 000000 = 0μA (default) 000001 = 5μA 111111 = 315μA

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Table 32. Address 29, TX Gain Configuration (Default = 3F0_{HEX})

DATA BITS	DEFAULT	DESCRIPTION
D9:D4	111111	TX VGA SPI Gain Control. Active when Address 29 D0 (TXVGA_GAIN_SPI_EN) = 1 000000 = MIN attenuation 111111 = MAX attenuation (default)
D3	0	Set to recommended value.
D2	0	TX DC Offset SPI Adjust Enable. 0 = By fuse (default) 1 = By SPI
D1	0	Pin TR6 SPI TX VGA Control Enable. 0 = By pin (default) 1 = By SPI Address 29 D9
D0	0	TX VGA Gain SPI Control Enable. 0 = By pin (default) 1 = By SPI Address 29 D9:D4

Table 33. Address 30, TX LO I/Q Configuration (Default = 080_{HEX})

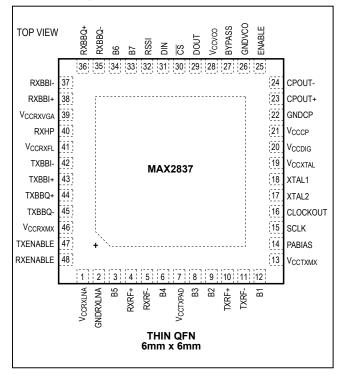
DATA BITS	DEFAULT	DESCRIPTION
D9:D6	0010	Set to recommended value.
D5	0	TX LO I/Q Phase SPI Adjust Enable. 0 = By trim (default) 1 = By Address 30 D4:D0
D4:D0	00000	TX LO I/Q Phase SPI Adjust. Active when Address 30 D5 (TXLO_IQ_SPI_EN) = 1. As trim word for fuse trim. 00000 = +4deg (Q lags I by 94degs, default) 01111 = +0deg 11111 = -4deg (Q lags I by 86degs)

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Table 34. Address 31, TX DC Correction Configuration (Default = 000_{HEX})

DATA BITS	DEFAULT	DESCRIPTION		
D9:D5	00000	TX DC Offset Correction for Q-Channel. Active when Address 29 D2 (TX_DCCORR_SPI_EN) = 1. As trim word for fuse trim. $00000 = 992/0\muA$ (+/-ve offset current, default) $00001 = 960/32\muA$ $00010 = 928/64\muA$ $01111 = 512/480\muA$ $11111 = 0/992\muA$		
D4:D0	00000	TX DC Offset Correction for I-Channel. Active when Address 29 D2 (TX_DCCORR_SPI_E 1.As trim word for fuse trim. 00000 = 992/0μA (+/-ve offset current, default) 00001 = 960/32μA 00010 = 928/64μA 01111 = 512/480μA 11111 = 0/992μA		

Pin Configuration



Chip Information

PROCESS: SiGe BiCMOS

Package Information

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	DOCUMENT	LAND
	CODE	NO.	PATTERN NO.
48 TQFN-EP	T4866+2	21-0141	90-0007

2.3GHz to 2.7GHz Wireless Broadband RF Transceiver

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	
0	5/07	Initial release	—
1	11/08	Corrected SPI description in Programmable Registers and 4-Wire SPI-Interface section	16
2	7/15	Added new <i>Temperature Sensor Readout Through DOUT Pin</i> , VAS Operating <i>Procedure</i> , VAS <i>Readout</i> , and VCO Subband Selection Through SPI sections. Added Register and Bit Descriptions.	16–33

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